

### **Power MOSFET**

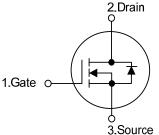
## 1.0A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

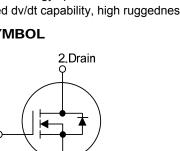
#### DESCRIPTION

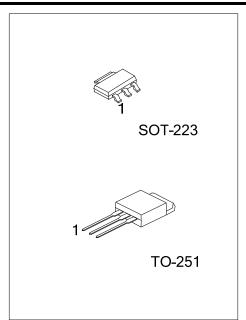
The UTC 1NM65-Q is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

#### **FEATURES**

- \*  $R_{DS(ON)}$  < 4.6 $\Omega$  @  $V_{GS}$  = 10V,  $I_D$  =0.5A
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability, high ruggedness
- SYMBOL







#### **ORDERING INFORMATION**

Ordering	Package	Pin Assignment			Dooking		
Lead Free	Lead Free Halogen Free		1	2	3	Packing	
-	1NM65G-AA3-R	SOT-223	G	D	S	Tape Reel	
1NM65L-TM3-T	1NM65G-TM3-T	TO-251	G	D	S	Tube	
Note: Pin Assignment: G: G	ate D: Drain S: Sourc	e					
	<ul> <li>(1) T: Tubel, R: Tape Reel</li> <li>(2) AA3: SOT-223, TM3: TO-251</li> <li>(3) L: Lead Free, G: Halogen Free and Lead Free</li> </ul>						
		1	Re'l	2020			
Lot Code 1NM 1NM		Lot Code			L: Lead ▶ G: Halog ▶ Data Co	gen Free	
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QW-R205-202.c

#### ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	650	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Drain Current	Continuous	I <sub>D</sub>	1.0	А
	Pulsed (Note 2)	I <sub>DM</sub>	4.0	Α
Avalanche Current (Note 2)		I <sub>AR</sub>	1.3	Α
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.6	V/ns
Power Dissipation	SOT-223	D	10	W
	TO-251	P <sub>D</sub>	28	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

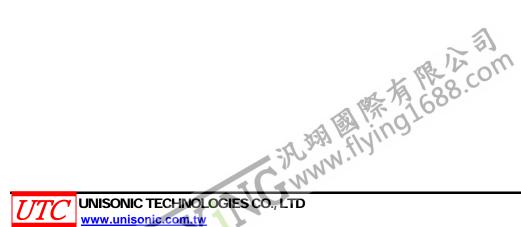
2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L=10mH,  $I_{AS}$ =1.3A,  $V_{DD}$ =50V,  $R_G$ =25  $\Omega$ , Starting  $T_J$  = 25°C.

4.  $I_{SD} \le 1.0A$ , di/dt $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ .

#### THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223	0	150	°C/W
	TO-251	θ <sub>JA</sub>	110	°C/W
Junction to Case	SOT-223	0	12.5	°C/W
	TO-251	θ <sub>JC</sub>	4.46	°C/W



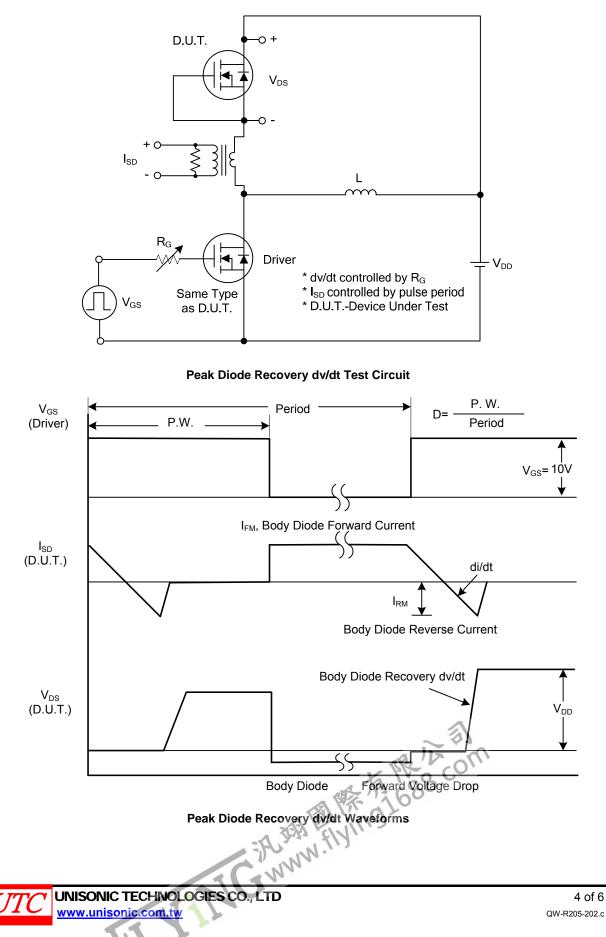
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PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA				V
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 650V, V_{GS} = 0V$			10	μA
Gate-Source Leakage Current	Forward	- I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> =0.5A			4.6	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C <sub>ISS</sub>			89		pF
Output Capacitance		C <sub>oss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f =1MHz		51		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			5.5		рF
SWITCHING CHARACTERISTIC	S						
Total Gate Charge (Note 1)		$Q_{G}$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A		13		nC
Gate-Source Charge		$Q_{GS}$	$I_{G}$ =100µA (Note 1, 2)		2		nC
Gate-Drain Charge		$Q_{GD}$			3.5		nC
Turn-On Delay Time (Note 1)		t <sub>D (ON)</sub>			28		ns
Turn-On Rise Time		t <sub>R</sub>	$V_{DD}$ =30V, $V_{GS}$ =10V, $I_D$ =0.5A, R <sub>G</sub> =25 $\Omega$ (Note 1, 2)		30		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>			54		ns
Turn-Off Fall Time		t <sub>F</sub>			36		ns
DRAIN-SOURCE DIODE CHARA	CTERISTICS	3					
Continuous Drain-Source Current		ls				1.0	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				4.0	Α
Drain-Source Diode Forward Voltage (Note 1)		V <sub>SD</sub>	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		trr	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V, dl/dt=100A/μs		160		nS
Body Diode Reverse Recovery Charge		Qrr			530		nC

#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

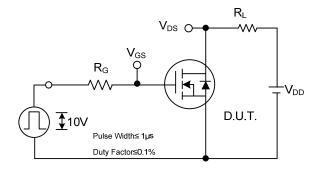
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle $\leq$ 2%.

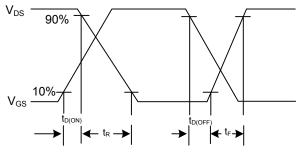
2. Essentially independent of operating temperature.

#### TEST CIRCUITS AND WAVEFORMS



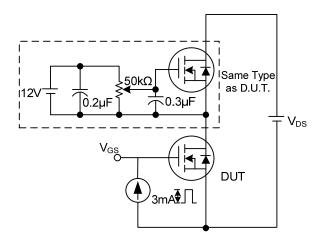
### **TEST CIRCUITS AND WAVEFORMS (Cont.)**



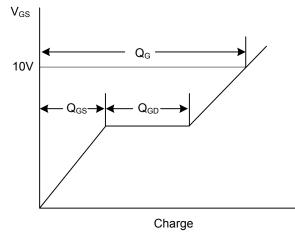


Switching Test Circuit

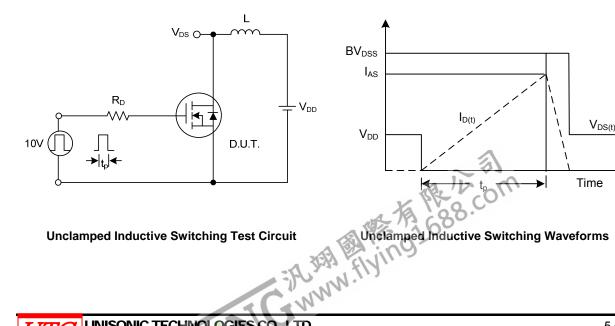




**Gate Charge Test Circuit** 

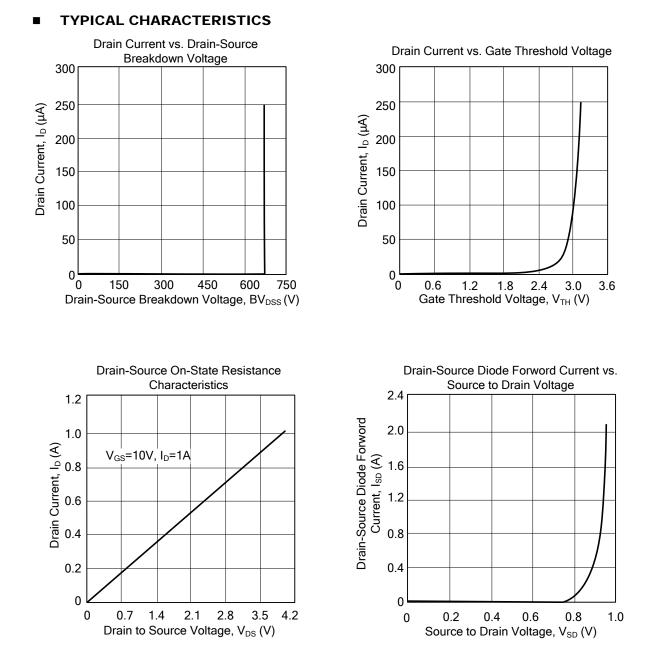


**Gate Charge Waveform** 





V<sub>DS(t)</sub>



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